Features

- 3228 with integrated high quality constant current IC and RGB LED chip.
- Built-in IC, with high precision of constant current and internal RGB chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology - number of LED stacked is not restricted.
- Cascading Enhancement Technology - any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGB output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

Description

The IN-PI32TATPRPGPB.ZR is 3.2*2.8*1.78mm RGB LED with integrated IC. It is a bending lead and top mount SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen

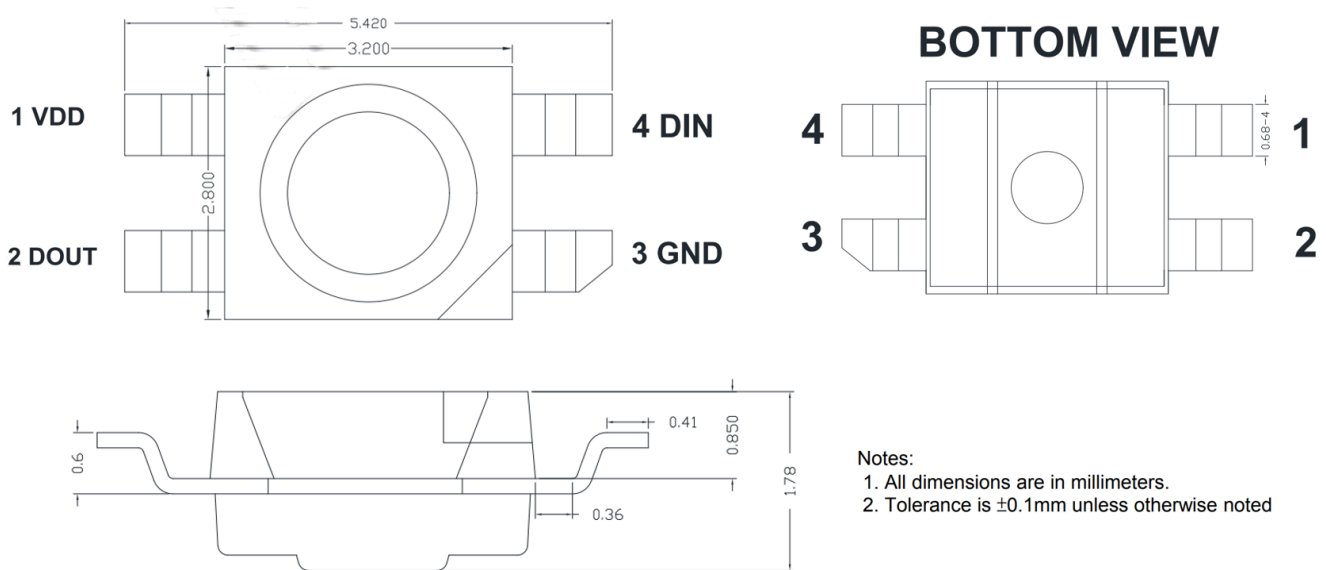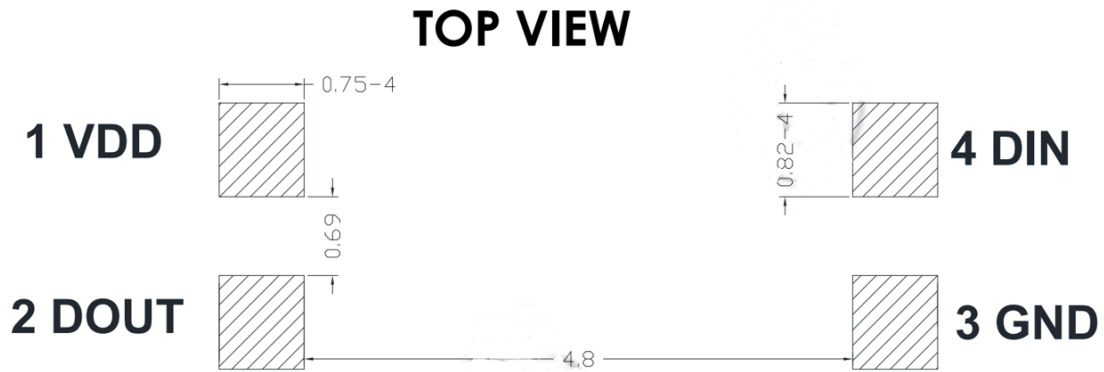## Package Outline Dimensions & Pin Configuration

Figure 1. IN-PI32TATPRPGPB.ZR Package Outline Dimensions

Pin Configuration

Number	Symbol	Function Description
1	VDD	Power supply LED
2	DOUT	Control data signal output
3	GND	Ground
4	DIN	Control data signal input

Recommended Dimensions for PCB

TOP VIEW

Notes:
1. Dimension in millimeter, tolerance is ±0.1mm unless otherwise noted.

Absolute Maximum Rating (Ta = 25 ℃, VSS=0V)

Parameter	Symbol	Range	Unit
Power supply voltage	V_{DD}	+3.7～+5.5	V
Logic input voltage	V_{IN}	-0.5 ~VDD+0.5	V
Operating temperature	T_{OPT}	−40 ~ +85	℃
Storage temperature	T_{STG}	−40 ~ +85	℃
ESD pressure(HBM)	V_{ESD}	2K	V
ESD pressure(DM)	V_{ESD}	200	V

LED Characteristics (Ta = 25℃)

Color	IN-PI32TATPRPGPB.ZR	
	Wavelength(nm)	Light Intensity(mcd)
Red	620-625	240-450
Green	515-520	580-1050
Blue	460-470	120-240

Recommended Operating Ranges *(unless otherwise specified, Ta= -20 ~ +70 ℃, VDD=4.5 ~ 5.5V, VSS=0V)*

Parameter	Symbol	Min.	Typ.	Max	Unit
The chip input voltage	V_{DD}	3	5	7.5	V
R / G / B output port withstand voltage	Vds	8.5	9	9.5	V
R / G / B output drive current	IO	9.6	12	14.4	mA
The signal input flip threshold	V_{IH}	0.7*VDD	0.9*VDD	-	V
	V_{IL}	0	0.1*VDD	0.3*VDD	V
Dout pull current capability	$IDOH$	-	15	-	mA
Dout current filling capacity	$IDOL$	-	30	-	mA
The frequency of PWM	F_{PWM}	3	4	5	KHZ
Static power consumption	I_{DD}	0.4	0.65	0.9	mA

Switching Characteristics *(VCC=5V, Ta=25℃)*

Parameter	Symbol	Min.	Typ.	Max	Unit	Test conditions
The speed of data transmission	*fDIN*	-	800	1100	KHZ	The duty ratio of 67% (data 1)
DOUT transmission delay	T_{PLH}	-	-	200	ns	DIN→DOUT
I_{OUT} Rise/Drop Time	T_r	-	-	400	ns	VDS=1.5 I_{OUT}=12mA
	T_f	-	-	400	ns	
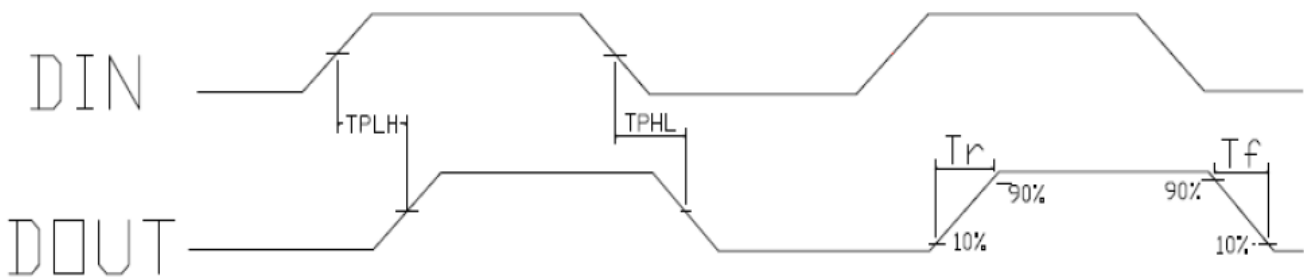
Timing Waveforms

1. Input Code
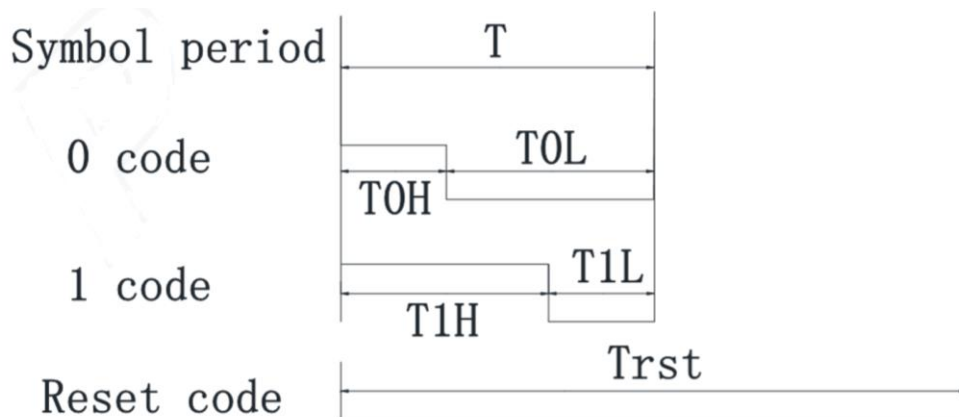
2. The data transmission time:

Name		Min	Standard Value	Max	Unit
T	Code Period	1.20	-	-	µs
T0H	0 code, high level time	0.2	0.32	0.4	µs
T0L	0 code, low level time	0.8	-	-	µs
T1H	1 code, high level time	0.58	0.62	1.0	µs
T1L	1 code, low level time	0.2	-	-	µs
Trst	Reset code, low level time	>80	-	-	µs

1. The protocol uses a unipolar zeroing code. Each symbol must have a low level. Each symbol in this protocol starts with a high level. The high time width determines the "0" or "1" code.
2. When writing programs, the minimum symbol period is 1.2µs.
3. The high time of "0" code and "1" code should be in accordance with the stipulated range in the above table. The low time requirement of "0" code and "1" code is less than 20µs.

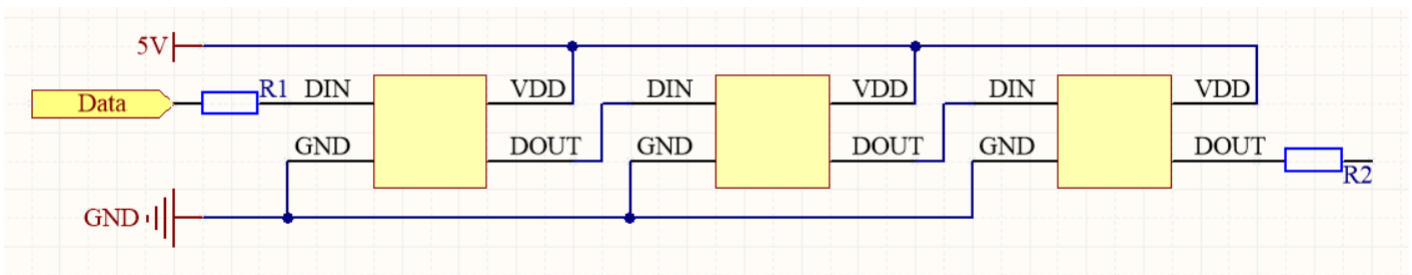3. Connection Scheme
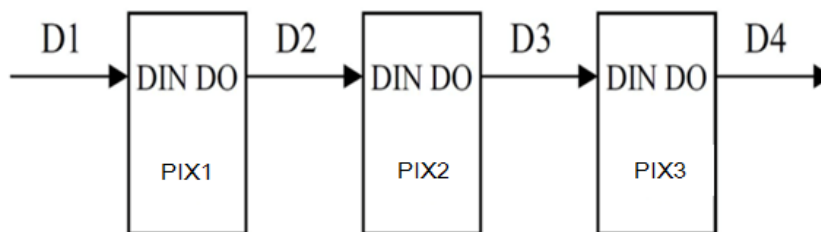
4. Data Transfer Format
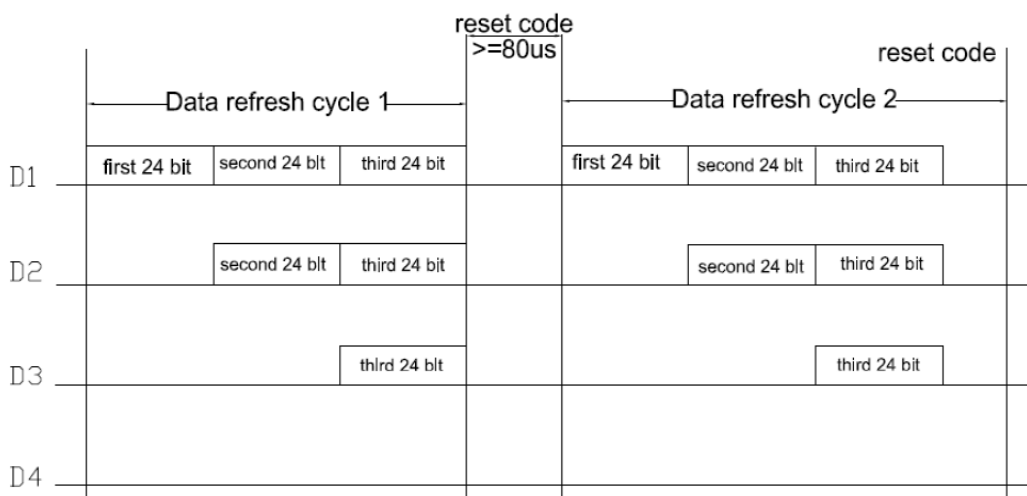
Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

5. 24-bit data format

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
R3	R2	R1	R0	B7	B6	B5	B4	B3	B2	B1	B0

Note: high starting, in order to send data (G7 - G6 - ....B0)

Typical Application Circuit

Note:
1. In the practical application circuit, the signal input and output pins of the IC signal input and output pins should be connected to the signal input and output terminals. In addition, to make the IC chip is more stable, even the capacitance between beads is essential back.
2. Application: used for soft lamp strip or hard light, lamp beads transmission distance is short, suggested in signal in time the clock line input and output end of each connected in series protection resistors, R1 of about 500 ohms.
3. Application: for module or general special-shaped products, lamp beads transmission distance is long, because of different wire and transmission distance, in the signal in time clock at both ends of the line on grounding protection resistance will be slightly different; to the actual use of fixed.
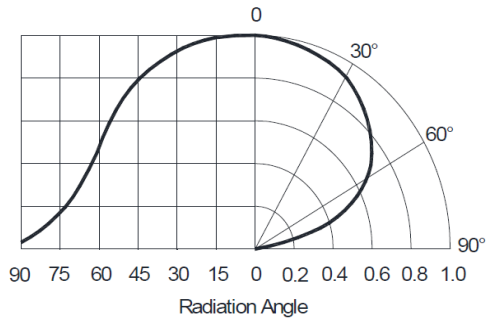
LED Performance Graph

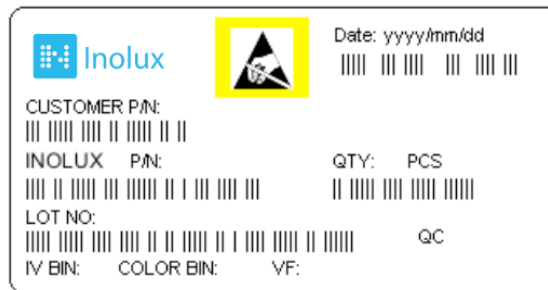Thermal Pad Temperature vs. Relative Light Output
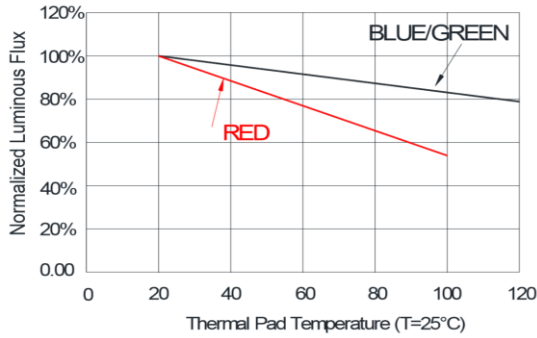
Wavelength Characteristics
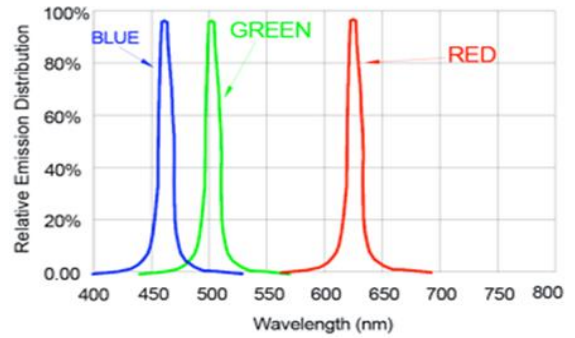
Typical Radiation Pattern   120°

Ordering Information

Product	Emission Color	Iv (mcd)	Orderable Part Number
IN-PI32TATPRPGPB.ZR	R	240-450	IN-PI32TATPRPGPB.ZR
	G	580-1050	
	B	120-240	

Label Specifications

Inolux P/N:

I	N	PI	-	32	T	A	T	P	R	P	G	P	B	.ZR	-	X	X	X	X
		Product		Package	Die Qty.	Variation	Orientation	Current	Color	Current	Color	Current	Color	Lead frame type		Customized Stamp-off			
Inolux		PI- Single trace IC		32TA = 3.2 x 2.8 x 1.78 mm (4 pins bending leads)			T = Top Mount	P=12mA	R = 625 nm	P=12mA	G = 520 nm	P=12mA	B = 470 nm	ZR = Z-Bend					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018, …..)				Month	Date	Serial

Tape and Reel

CATHODE IDENTIFICATION

TAPE FEED DIRECTION

COVER TAPE

CARRIER TAPE

REEL(178x12mm)
(INNER 2000pcs LED MAX)

ESD POLYETHYLENE BAG

ATTENTION
OBSERVE PRECAUTIONS
ELECTROSTATIC
SENSITIVE DEVICES
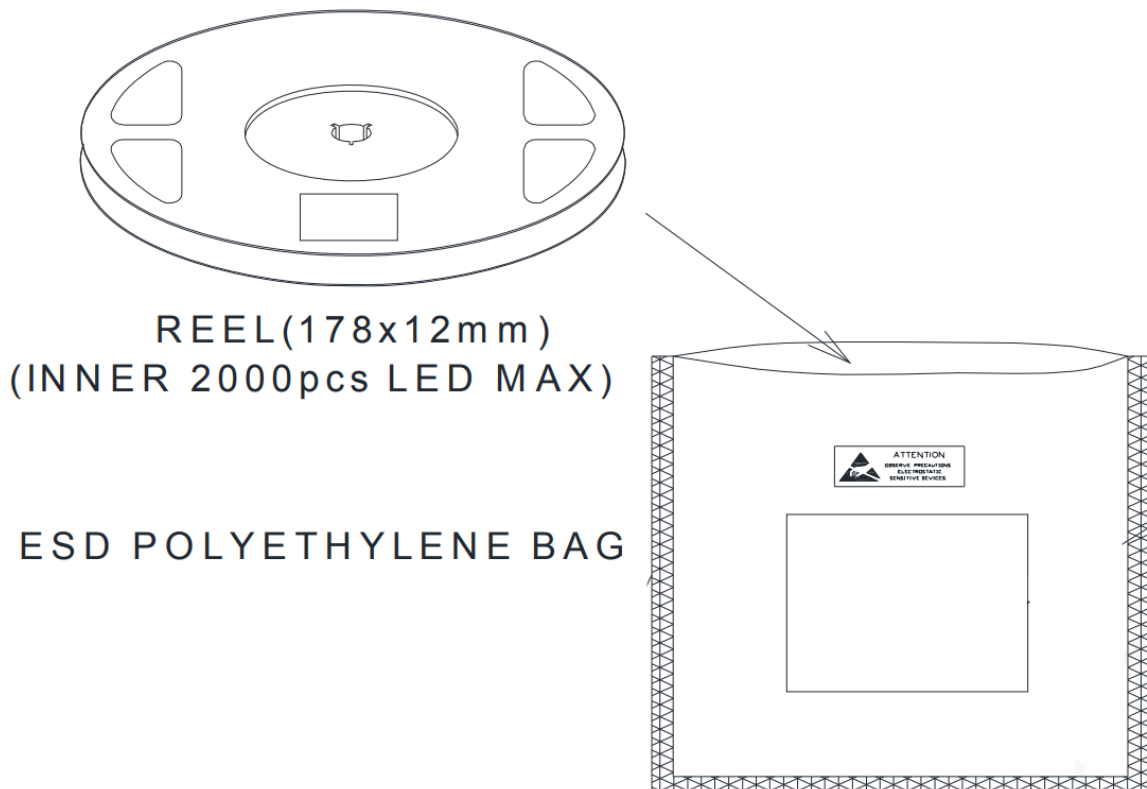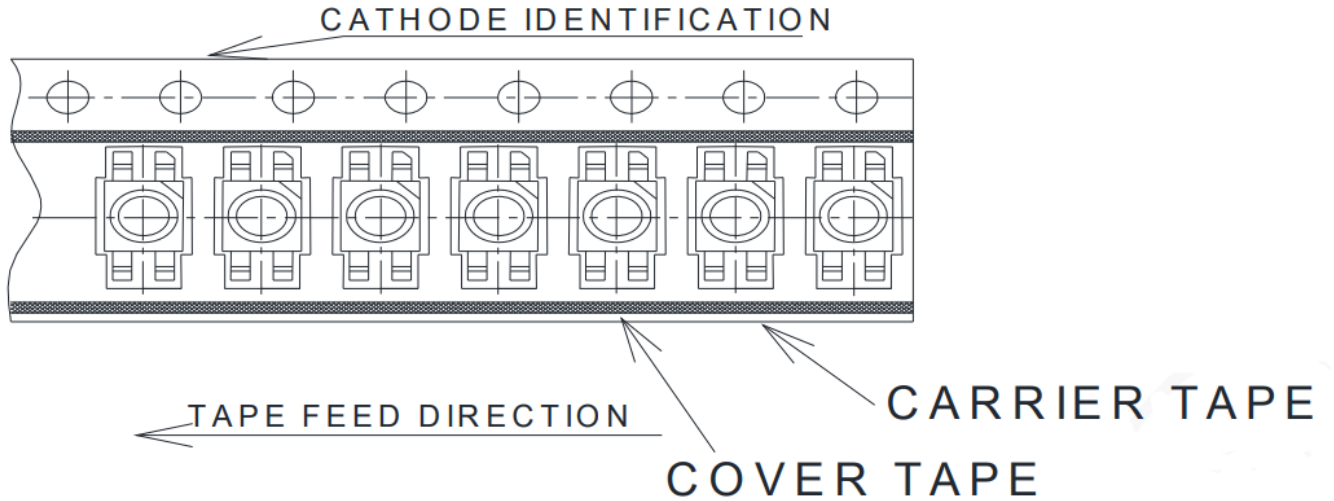
Precautions

Please read the following notes before using the product:

1. Storage

1.1 Do not open moisture proof bag before the products are ready to use.

1.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.

1.3 The LEDs should be used within a year.

1.4 After opening the package, the LEDs should be kept at 30℃ or less and 60%RH or less.

1.5 The LEDs should be used within 72 hours after opening the package.

1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5℃ for 24 hours.

2. Soldering Condition
Recommended soldering conditions:
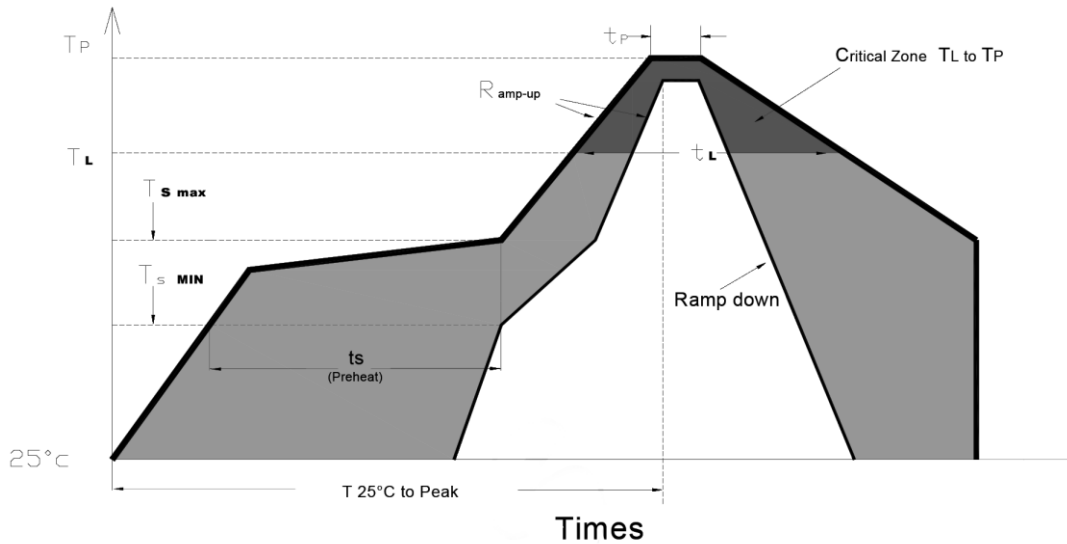
| Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts $_{max}$ to Tp)	3℃/second max.
Preheat: Temperature Min (Ts $_{min}$)	150℃
Preheat: Temperature Min (Ts $_{max}$)	200℃
Preheat: Time (ts $_{min\ to}$ ts $_{max}$)	60-180 seconds
Time Maintained Above: Temperature (T$_L$)	217 ℃
Time Maintained Above: Time (t $_L$)	60-150 seconds
Peak/Classification Temperature (T $_P$)	240 ℃
Time Within 5℃ of Actual Peak Temperature (tp)	<10 seconds
Ramp-Down Rate	6℃/second max.
Time 25 ℃ to Peak Temperature	<6 minutes max.

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure
of the LED.

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260℃ for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
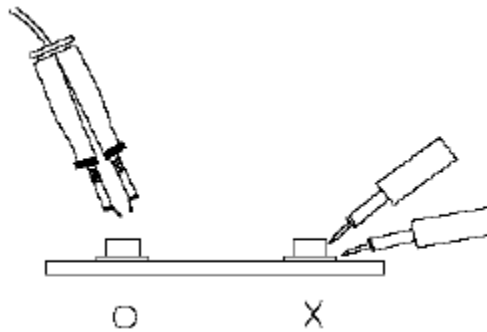
5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-28-2022
Add tape and reel drawing	10	1.1	09-15-2022

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